

Product specification Replaces data sheet of 1996 Feb IC24 Data Handbook 1997 Apr 28





## 74LVC10

#### **FEATURES**

- Wide supply voltage range of 1.2 V to 3.6 V
- In accordance with JEDEC standard no. 8-1A.
- Inputs accept voltages up to 5.5 V
- CMOS low power consumption
- Direct interface with TTL levels
- Output capability: standard
- I<sub>CC</sub> category: SSI

### QUICK REFERENCE DATA

GND = 0 V;  $T_{amb} = 25^{\circ}C$ ;  $t_r = t_f \le 2.5 \text{ ns}$ 

### DESCRIPTION

The 74LVC10 is a high performance, low power, low voltage, Si gate CMOS device and superior to most advanced CMOS compatible TTL families.

The 74LVC10 provides the 3-input NAND function.

SYMBOL	PARAMETER CONDITIONS		TYPICAL	UNIT
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nA, nB, nC to nY	$\begin{array}{l} C_{L}=50 \text{ pF};\\ V_{CC}=3.3 \text{ V} \end{array}$	3.9	ns
Cl	Input capacitance		5.0	pF
C <sub>PD</sub>	Power dissipation capacitance per gate	$V_I = GND$ to $V_{CC}^1$	26	pF

#### NOTE:

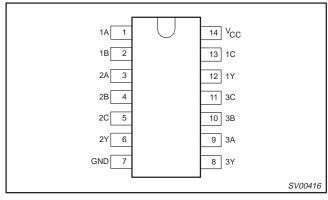
1.  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W)

 $\begin{array}{l} \mathsf{P}_{D} = \mathsf{C}_{PD} \times \mathsf{V}_{CC}{}^2 \times \mathsf{f}_i + \mathop{\textstyle\sum}\limits_{} (\mathsf{C}_L \times \mathsf{V}_{CC}{}^2 \times \mathsf{f}_o) \text{ where:} \\ \mathsf{f}_i = \mathsf{input} \text{ frequency in MHz; } \mathsf{C}_L = \mathsf{output} \text{ load capacity in } \mathsf{pF}; \\ \mathsf{f}_o = \mathsf{output} \text{ frequency in MHz; } \mathsf{V}_{CC} = \mathsf{supply voltage in } \mathsf{V}; \\ \mathop{\textstyle\sum}\limits_{} (\mathsf{C}_L \times \mathsf{V}_{CC}{}^2 \times \mathsf{f}_o) = \mathsf{sum of the outputs.} \end{array}$ 

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic SO	-40°C to +85°C	74LVC10 D	74LVC10 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +85°C	74LVC10 DB	74LVC10 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +85°C	74LVC10 PW	74LVC10PW DH	SOT402-1

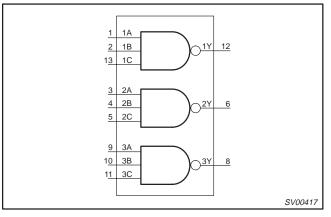
#### **PIN CONFIGURATION**



#### **PIN DESCRIPTION**

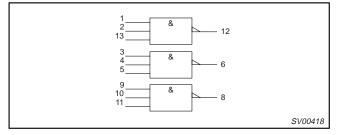
PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 9	1A – 3A	Data inputs
2, 4, 10	1B – 3B	Data inputs
7	GND	Ground (0 V)
12, 6, 8	1Y – 3Y	Data outputs
13, 5, 11	1C – 3C	Data inputs
14	V <sub>CC</sub>	Positive supply voltage

### LOGIC SYMBOL

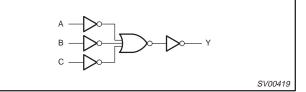


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### LOGIC SYMBOL (IEEE/IEC)



#### LOGIC DIAGRAM (ONE GATE)



#### **RECOMMENDED OPERATING CONDITIONS**

### FUNCTION TABLE

	INPUTS				
nA	nB	nC	nY		
L	L	L	Н		
L	L	н	Н		
L	н	L	Н		
L	Н	Н	Н		
Н	L	L	Н		
Н	L	н	Н		
Н	н	L	Н		
Н	Н	Н	L		

NOTES:

H = HIGH voltage level L = LOW voltage level

CYMDOL	PARAMETER	CONDITIONS	LIM			
SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT	
V <sub>CC</sub>	DC supply voltage (for max. speed performance)		2.7	3.6	V	
V <sub>CC</sub>	DC supply voltage (for low-voltage applications)		1.2	3.6	V	
VI	DC input voltage range		0	5.5	V	
V <sub>I/O</sub>	DC input voltage range for I/Os		0	V <sub>CC</sub>	V	
Vo	DC output voltage range		0	V <sub>CC</sub>	V	
T <sub>amb</sub>	Operating free-air temperature range		-40	+85	°C	
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times	$V_{CC} = 1.2 \text{ to } 2.7 \text{V}$ $V_{CC} = 2.7 \text{ to } 3.6 \text{V}$	0 0	20 10	ns/V	

### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER CONDITIONS		RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +6.5	V
I <sub>IK</sub>	DC input diode current	$V_{I} < 0$	-50	mA
VI	DC input voltage	Note 2	-0.5 to +5.5	V
V <sub>I/O</sub>	DC input voltage range for I/Os		–0.5 to V <sub>CC</sub> +0.5	V
I <sub>OK</sub>	DC output diode current	$V_{O} > V_{CC} \text{ or } V_{O} < 0$	± 50	mA
V <sub>OUT</sub>	DC output voltage	Note 2	-0.5 to V <sub>CC</sub> +0.5	V
I <sub>OUT</sub>	DC output source or sink current	$V_{O} = 0$ to $V_{CC}$	± 50	mA
I <sub>GND</sub> , I <sub>CC</sub>	DC V <sub>CC</sub> or GND current		±100	mA
T <sub>stg</sub>	Storage temperature range		-60 to +150	°C
P <sub>TOT</sub>	Power dissipation per package – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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#### DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

			L	UNIT		
SYMBOL	PARAMETER	TEST CONDITIONS	Temp = -40°C to +85°C			
				TYP <sup>1</sup>	MAX	1
M		$V_{CC} = 1.2V$	V <sub>CC</sub>			v
V <sub>IH</sub>	HIGH level Input voltage	V <sub>CC</sub> = 2.7 to 3.6V	2.0			1 <sup>v</sup>
M		$V_{CC} = 1.2V$			GND	v
VIL	LOW level Input voltage	V <sub>CC</sub> = 2.7 to 3.6V			0.8	
		$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -12mA$	V <sub>CC</sub> -0.5			
M		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -100\mu A$	V <sub>CC</sub> -0.2	V <sub>CC</sub>		v
V <sub>OH</sub>	HIGH level output voltage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -12mA$	V <sub>CC</sub> -0.6			
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -24mA$	V <sub>CC</sub> -1.0			1
		$V_{CC} = 2.7 V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 12 mA$			0.40	
V <sub>OL</sub>	LOW level output voltage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$			0.20	V
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 24mA$			0.55	1
l	Input leakage current	$V_{CC} = 3.6V$ ; $V_I = 5.5V$ or GND Not for I/O pins		±0.1	±5	μA
I <sub>IHZ</sub> /I <sub>ILZ</sub>	Input current for common I/O pins	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}$		±0.1	±15	μA
I <sub>OZ</sub>	3-State output OFF-state current	$V_{CC} = 3.6V; V_I = V_{IH} \text{ or } V_{IL}; V_O = V_{CC} \text{ or } GND$		0.1	±10	μA
I <sub>CC</sub>	Quiescent supply current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}; I_O = 0$		0.1	20	μA
$\Delta I_{CC}$	Additional quiescent supply current per input pin	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$ ; $I_{O} = 0$		5	500	μΑ

NOTE:

1. All typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.

#### **AC CHARACTERISTICS**

GND = 0 V;  $t_r$  =  $t_f$   $\leq~$  2.5 ns; C\_L = 50 pF

SYMBOL PARAMETER			LIMITS						
		WAVEFORM V <sub>CC</sub> = 3.3V ±0.3V		V <sub>CC</sub> = 2.7V		V <sub>CC</sub> = 1.2V	UNIT		
		MIN	TYP <sup>1</sup>	MAX	MIN	MAX	TYP		
t <sub>PHL</sub> / t <sub>PLH</sub>	Propagation delay nA, nB, nC to nY	Figures 1, 2	-	3.9	6.4	-	7.5	-	ns

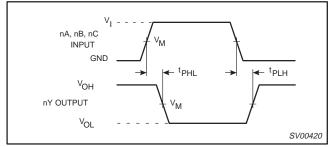
NOTE:

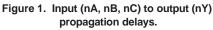
1. These typical values are at V\_{CC} = 3.3V and T\_{amb} = 25°C.

### AC WAVEFORMS

 $\begin{array}{l} V_M = 1.5 \; V \; at \; V_{CC} \; \geq \; 2.7 \; V \\ V_M = 0.5 \bullet V_{CC} \; at \; V_{CC} < 2.7 \; V \end{array}$ 

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are the typical output voltage drop that occur with the output load.





### **TEST CIRCUIT**

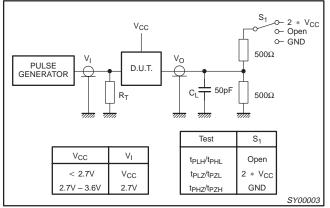
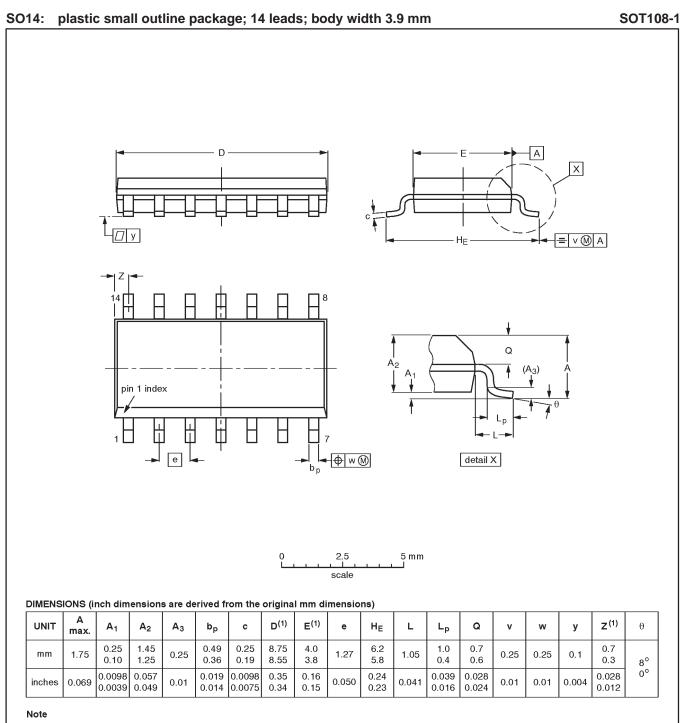


Figure 2. Load circuitry for switching times.

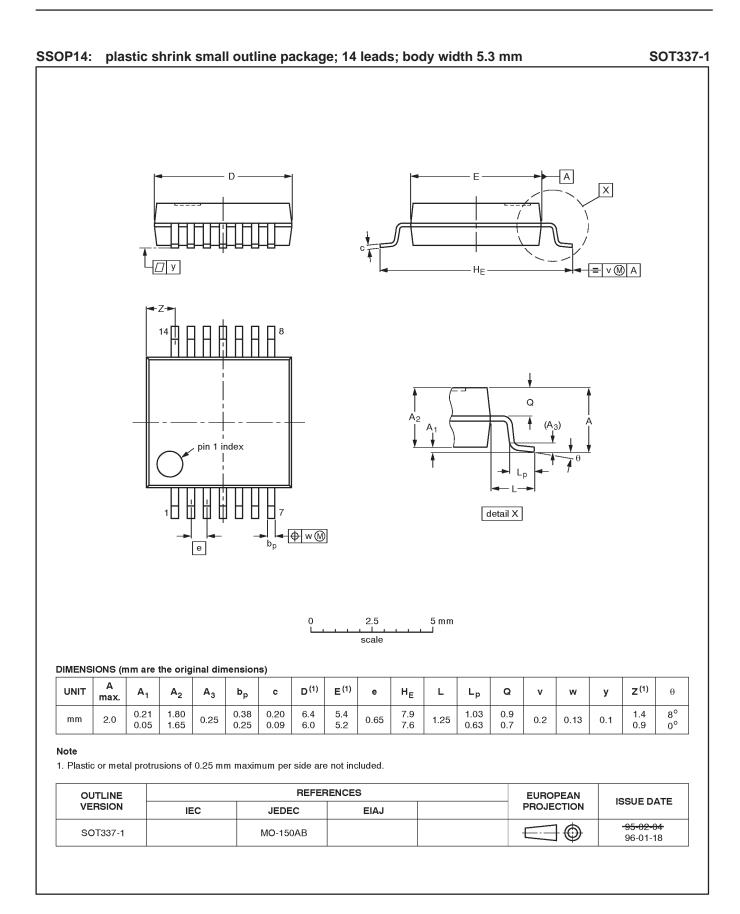
### 74LVC10



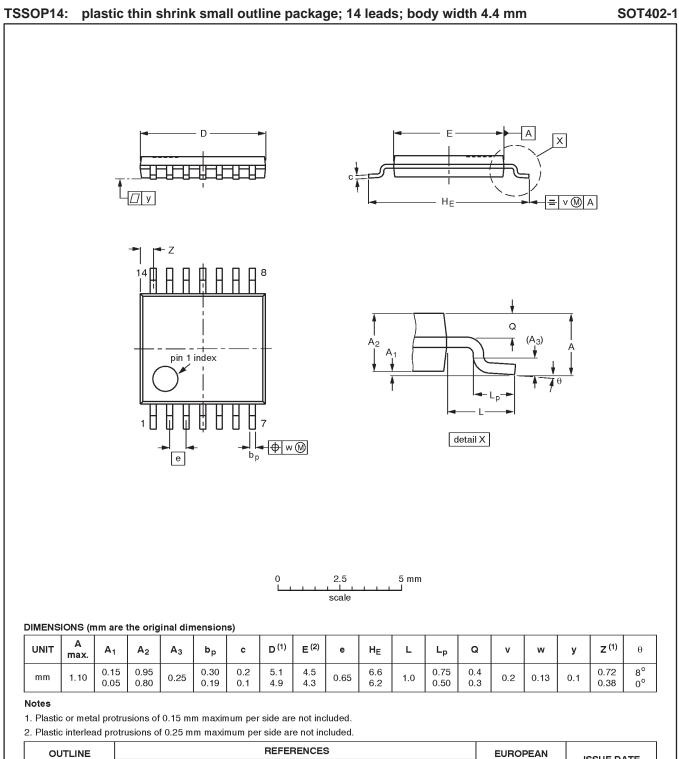
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	
SOT108-1	076E06S	MS-012AB				<del>91-08-13</del> 95-01-23

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DEFINITIONS					
Data Sheet Identification	Product Status	Definition			
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.			
		This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.			
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